

### STGW40N120KD

### 40 A, 1200 V, short circuit rugged IGBT

#### **Features**

- Low on-losses
- High current capability
- Low gate charge
- Short circuit withstand time 10 µs
- IGBT co-packaged with ultra fast free-wheeling diode

### **Application**

■ Motor control

### **Description**

This IGBT utilizes the advanced PowerMESH™ process resulting in an excellent trade-off between switching performance and low on-state behavior.

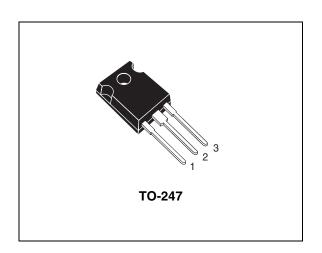


Figure 1. Internal schematic diagram

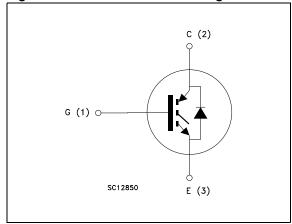


Table 1. Device summary

Order code	Marking	Package	Packaging
STGW40N120KD	GW40N120KD	TO-247	Tube

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STGW40N120KD Electrical ratings

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector-emitter voltage (V <sub>GE</sub> = 0)	1200	V
I <sub>C</sub> <sup>(1)</sup>	Continuous collector current at T <sub>C</sub> = 25 °C	80	Α
I <sub>C</sub> <sup>(1)</sup>	Continuous collector current at T <sub>C</sub> = 100 °C	40	Α
I <sub>CL</sub> (2)	Turn-off latching current	85	Α
I <sub>CP</sub> (3)	Pulsed collector current	120	Α
V <sub>GE</sub>	Gate-emitter voltage	±25	V
t <sub>SCW</sub>	Short circuit withstand time, $V_{CE}$ = 0.5 $V_{(BR)CES}$ $T_j$ = 125 °C, $R_G$ = 10 $\Omega$ , $V_{GE}$ = 12 $V$	10	μs
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	240	W
IF	Diode RMS forward current at T <sub>C</sub> = 25 °C	30	Α
I <sub>FSM</sub>	Surge non repetitive forward current $t_p = 10 \text{ ms}$ sinusoidal	100	Α
T <sub>j</sub>	Operating junction temperature	- 55 to 125	°C

<sup>1.</sup> Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

- 2. Vclamp = 80% of V<sub>CES</sub>, T<sub>j</sub> =125 °C, R<sub>G</sub>=10  $\Omega$ , V<sub>GE</sub>=15 V
- 3. Pulse width limited by maximum junction temperature and turn-off within RBSOA

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case IGBT	0.42	°C/W
R <sub>thj-case</sub>	Thermal resistance junction-case diode	1.6	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient	50	°C/W

Electrical characteristics STGW40N120KD

### 2 Electrical characteristics

 $(T_J = 25 \, ^{\circ}C \text{ unless otherwise specified})$ 

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)CES</sub>	Collector-emitter breakdown voltage (V <sub>GE</sub> = 0)	I <sub>C</sub> = 1 mA	1200			٧
V <sub>CE(sat)</sub>	Collector-emitter saturation voltage	$V_{GE}$ = 15 V, $I_{C}$ = 30 A $V_{GE}$ = 15 V, $I_{C}$ = 30 A, $T_{J}$ =125 °C		2.8	3.85	V
V <sub>GE(th)</sub>	Gate threshold voltage	V <sub>CE</sub> = V <sub>GE</sub> , I <sub>C</sub> = 1mA	4.5		6.5	V
I <sub>CES</sub>	Collector cut-off current (V <sub>GE</sub> = 0)	V <sub>CE</sub> =1200 V V <sub>CE</sub> =1200 V, T <sub>J</sub> =125 °C			500 10	μA mA
I <sub>GES</sub>	Gate-emitter leakage current (V <sub>CE</sub> = 0)	V <sub>GE</sub> =± 20 V			± 100	nA

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$egin{array}{c} C_{ m ies} \ C_{ m res} \end{array}$	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>CE</sub> = 25 V, f = 1 MHz, V <sub>GE</sub> =0	-	2577 196 39.5	-	pF pF pF
Q <sub>g</sub> Q <sub>ge</sub> Q <sub>gc</sub>	Total gate charge Gate-emitter charge Gate-collector charge	V <sub>CE</sub> = 960 V, I <sub>C</sub> = 30 A,V <sub>GE</sub> =15 V	-	126 22.2 67	-	nC nC nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub> (di/dt) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$V_{CC}$ = 960 V, $I_{C}$ = 30 A $R_{G}$ = 10 $\Omega$ , $V_{GE}$ = 15 V, (see Figure 2)	-	48 40 540	-	ns ns A/µs
t <sub>d(on)</sub> t <sub>r</sub> (di/dt) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 960 \text{ V, } I_{C} = 30 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V,}$ $T_{J} = 125 \text{ °C (see Figure 2)}$	-	45 38 665	-	ns ns A/µs
$\begin{array}{c} t_{r}(V_{off}) \\ t_{d}(_{off}) \\ t_{f} \end{array}$	Off voltage rise time Turn-off delay time Current fall time	$V_{CC}$ = 960 V, $I_{C}$ = 30 A $R_{G}$ = 10 $\Omega$ , $V_{GE}$ = 15 V, (see Figure 2)	-	84 338 210	-	ns ns ns
$t_r(V_{off})$ $t_d(_{off})$ $t_f$	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 960 \text{ V, } I_{C} = 30 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V,}$ $T_{J} = 125 \text{ °C (see Figure 2)}$	-	144 420 360	-	ns ns ns

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Eon <sup>(1)</sup>	Turn-on switching losses	$V_{CC} = 960 \text{ V}, I_{C} = 30 \text{ A}$		3.7		mJ
E <sub>off</sub> (2)	Turn-off switching losses	$R_G=10 \Omega$ , $V_{GE}=15 V$ ,	-	5.7	-	mJ
E <sub>ts</sub>	Total switching losses	(see Figure 2)		9.4		mJ
Eon (1)	Turn-on switching losses	$V_{CC} = 960 \text{ V}, I_{C} = 30 \text{ A}$		4.7		mJ
E <sub>off</sub> (2)	Turn-off switching losses	$R_{G}$ = 10 $\Omega$ , $V_{GE}$ = 15 V,	-	9.3	-	mJ
E <sub>ts</sub>	Total switching losses	T <sub>J</sub> = 125 °C (see Figure 2)		14		mJ

Eon is the turn-on losses when a typical diode is used in the test circuit in Figure 2. If the IGBT is offered
in a package with a co-pack diode, the co-pack diode is used as external diode. IGBTs and diode are at
the same temperature (25°C and 125°C)

Table 8. Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>F</sub>	Forward on-voltage	I <sub>F</sub> = 20 A I <sub>F</sub> = 20 A, T <sub>J</sub> = 125 °C	-	1.9 1.7	-	V V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>rrm</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 20 \text{ A}, V_R = 45 \text{ V},$ $di/dt = 100 \text{ A/}\mu\text{s}$ (see Figure 5)	-	84 235 5.6	-	ns nC A
t <sub>rr</sub> Q <sub>rr</sub> I <sub>rrm</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 20 \text{ A}, V_R = 45 \text{ V},$ $T_J = 125 ^{\circ}\text{C},$ $di/dt = 100 \text{A/µs}$ (see Figure 5)	-	152 722 9	-	ns nC A



<sup>2.</sup> Turn-off losses include also the tail of the collector current

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### 3 Test circuits

Figure 2. Test circuit for inductive load switching

Figure 3. Gate charge test circuit

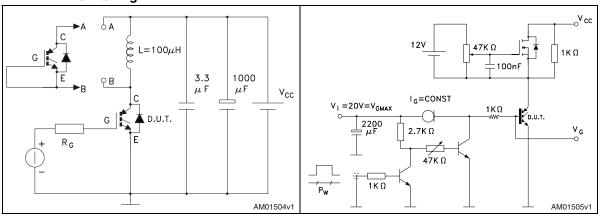
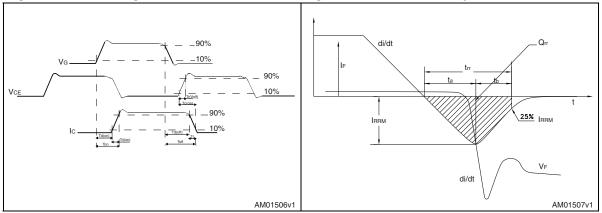


Figure 4. Switching waveform

Figure 5. Diode recovery time waveform



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### 4 Package mechanical data

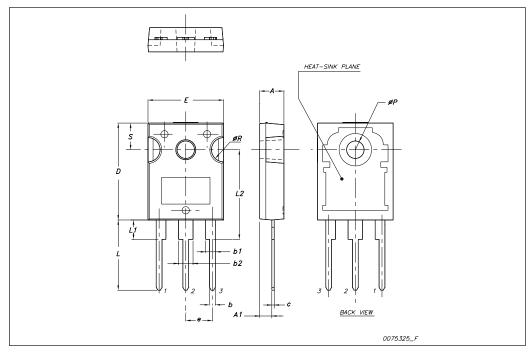
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Dis.		mm.					
Dim.	Min.	Тур.	Max.				
A	4.85		5.15				
A1	2.20		2.60				
b	1.0		1.40				
b1	2.0		2.40				
b2	3.0		3.40				
С	0.40		0.80				
D	19.85		20.15				
E	15.45		15.75				
е		5.45					
L	14.20		14.80				
L1	3.70		4.30				
L2		18.50					
øΡ	3.55		3.65				
øR	4.50		5.50				
S		5.50					



STGW40N120KD Revision history

# 5 Revision history

Table 9. Document revision history

Date	Revision	Changes
22-Jan-2009	1	Initial release
29-Jun-2009	2	Document status promoted from preliminary data to datasheet.
09-Jul-2009	3	Inserted dynamic values <i>Table 5 on page 4</i> , <i>Table 6 on page 5</i> and <i>Table 7 on page 5</i> .

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